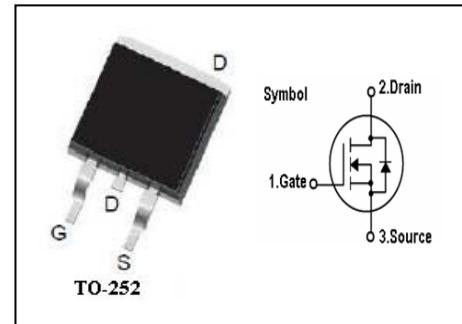


N-Channel MOSFET

Features

- 100V,70A,R_{ds(on)}(typ)=9.2mΩ @ V_{gs}=10V
- High Ruggedness
- Fast Switching
- 100% Avalanche Tested
- Improved dv/dt Capability



General Description

This Power MOSFET is produced using Si-Tech's advanced Trench MOS Technology. This latest technology has been especially designed to minimize on-state resistance, have a high rugged avalanche characteristics. These devices are well suited for low voltage application such as automotive, DC/DC converters, and high efficiency switch for power management in portable and battery products.

Absolute Maximum Ratings

Symbol	Parameter	Value	Units
V _{DSS}	Drain-Source Voltage	100	V
I _D	Continuous Drain Current (TC=25 °C)	70	A
	Continuous Drain Current (TC=100°C)	58	A
I _{DM}	Pulsed Drain Current (Note 1)	280	A
V _{GS}	Gate-Source Voltage	±25	V
E _{AS}	Single Pulsed Avalanche Energy (Note 2)	270	mJ
P _D	Maximum Power Dissipation (TC=25 °C)	131	W
	Derating Factor above 25°C	0.87	W/°C
T _J	Operating Junction Temperature Range	-55 to +175	°C
T _{STG}	Storage Temperature Range	-55 to +175	°C

Thermal Characteristics

Symbol	Parameter	Max.	Units
R _{th j-c}	Thermal Resistance, Junction to case	1.14	°C/W
R _{th j-a}	Thermal Resistance, Junction to Ambient	63	°C/W

Electrical Characteristics ($T_c=25^\circ C$ unless otherwise noted)

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{GS}=0V, I_D=250\mu A$	100	-	-	V
I_{DSS}	Drain-Source Leakage Current	$V_{DS}=75V, V_{GS}=0V$	-	-	1	μA
I_{GSS}	Gate Leakage Current, Forward	$V_{GS}=25V, V_{DS}=0V$	-	-	100	nA
	Gate Leakage Current, Reverse	$V_{GS}=-25V, V_{DS}=0V$	-	-	-100	nA
$V_{GS(th)}$	Gate Threshold Voltage	$V_{GS}=V_{DS}, I_D=250\mu A$	2.4	-	3.6	V
$R_{DS(on)}$	Drain-Source On-State Resistance	$V_{GS}=10V, I_D=40A$	-	9.2	11	$m \Omega$
Q_g	Total Gate Charge	$V_{DD}=60V$ $V_{GS}=10V$ $I_D=60A$ (Note 3)	-	102	-	nC
Q_{gs}	Gate-Source Charge		-	16	-	nC
Q_{gd}	Gate-Drain Charge		-	22	-	nC
$t_{d(on)}$	Turn-on Delay Time	$V_{DD}=37.5V, V_{GS}=10V$ $I_D=45A, R_G=4.7\Omega$ $T_c=25^\circ C$ (Note 3)	-	22	-	ns
t_r	Turn-on Rise Time		-	33	-	ns
$t_{d(off)}$	Turn-off Delay Time		-	73	-	ns
t_f	Turn-off Fall Time		-	41	-	ns
C_{iss}	Input Capacitance -	$V_{DS}=25V$ $V_{GS}=0V$ $f = 1MHz$	-	4865	-	pF
C_{oss}	Output Capacitance		-	1471	-	pF
C_{rss}	Reverse Transfer Capacitance		-	663	-	pF

Source-Drain Diode Characteristics ($T_c=25^\circ C$ unless otherwise noted)

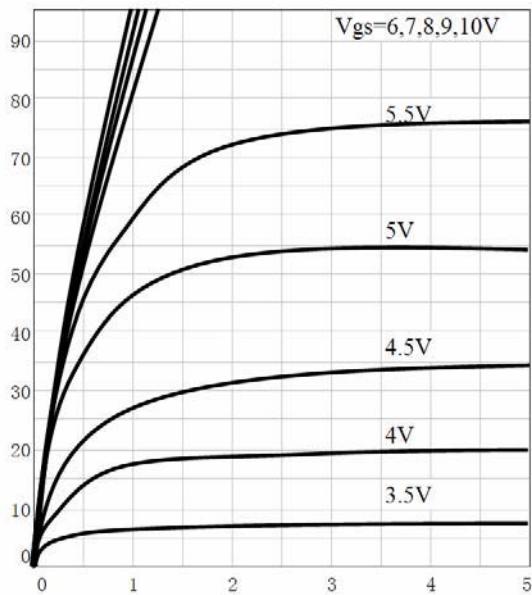
Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
I_s	Continuous Source Diode Forward Current	-	-	70	A	
I_{sm}	Pulsed Source Diode Forward Current (Note 1)	-	-	280	A	
V_{SD}	Forward On Voltage	$V_{GS}=0V, I_s=45A$	-	-	1.3	V
t_{rr}	Reverse Recovery Time	$V_{GS}=0V, I_s=45A$ $dI/dt = 100A/us$	-	44	-	ns
Q_{rr}	Reverse Recovery Charge		-	92	-	nC

Notes:

1. Repetitive Rating: Pulse width limited by maximum junction temperature
2. $L=0.5mH$, $V_{DD}=50V$, $R_G=25\Omega$, Starting $T_J=25^\circ C$
3. Pulse Width ≤ 300 us; Duty Cycle $\leq 2\%$

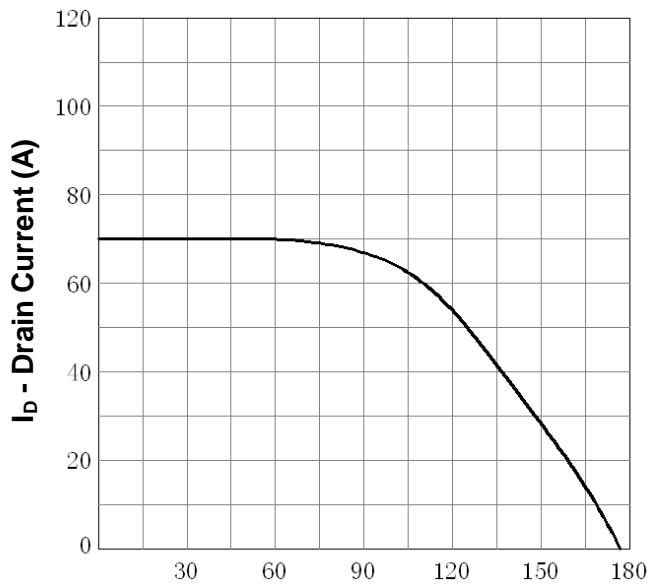
Typical Characteristics

Output Characteristics



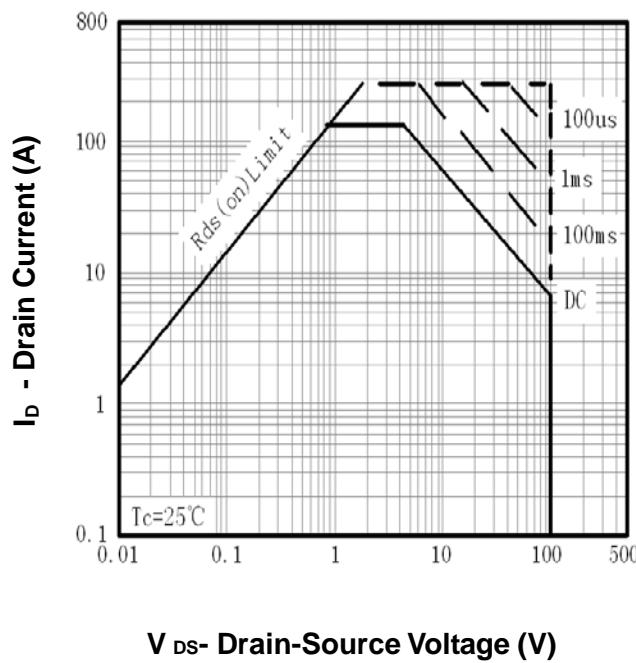
V_{DS} - Drain-Source Voltage (V)

Drain Current



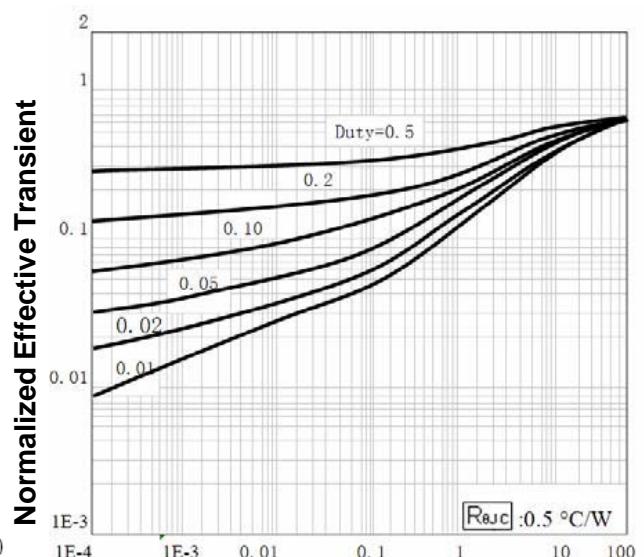
T_j - Junction Temperature (°C)

Safe Operation Area



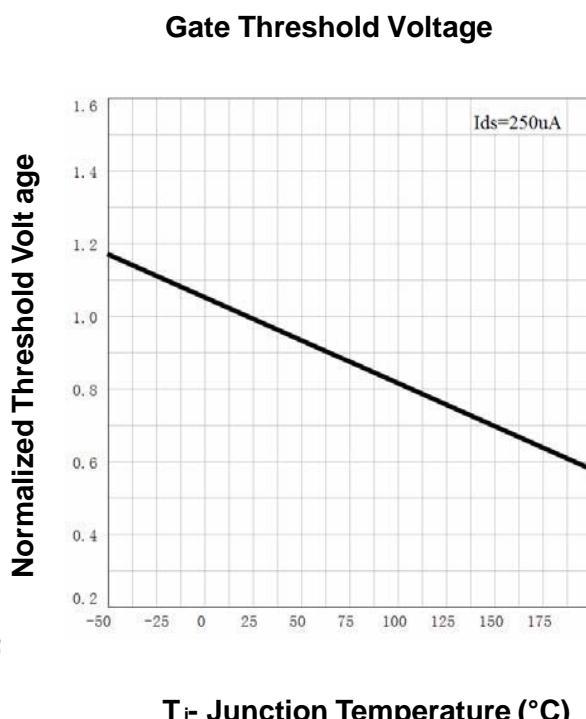
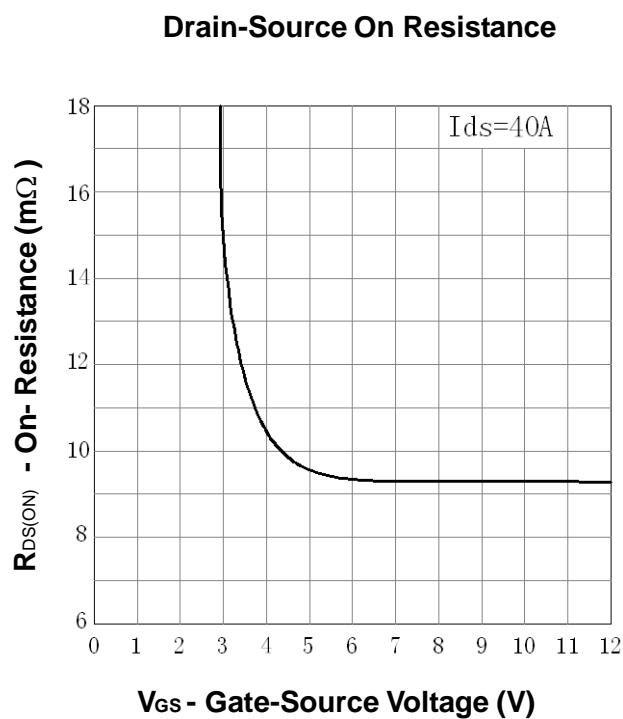
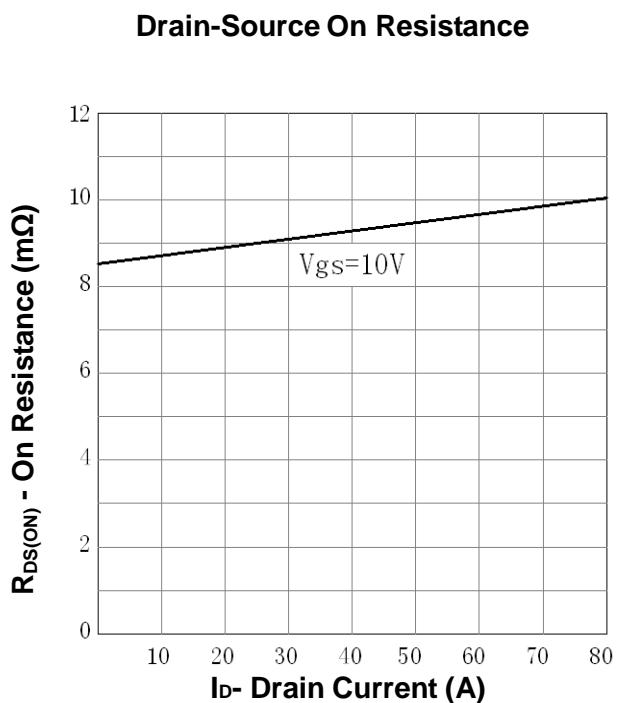
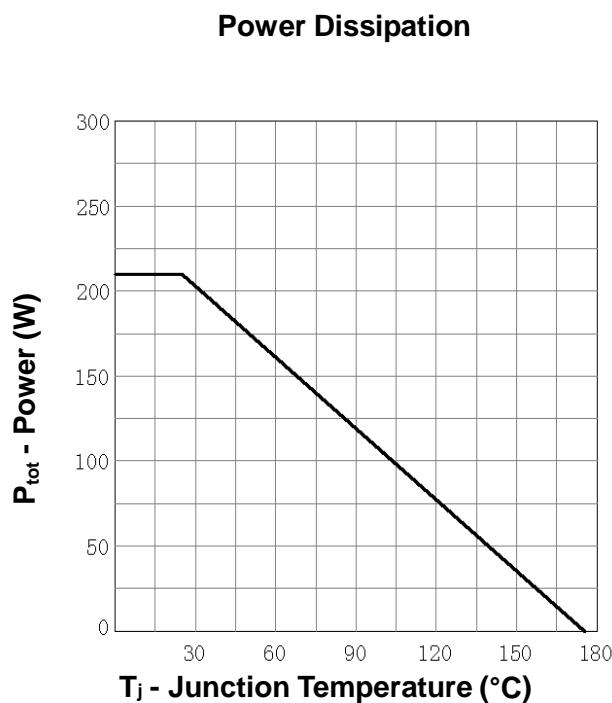
V_{DS} - Drain-Source Voltage (V)

Thermal Transient Impedance

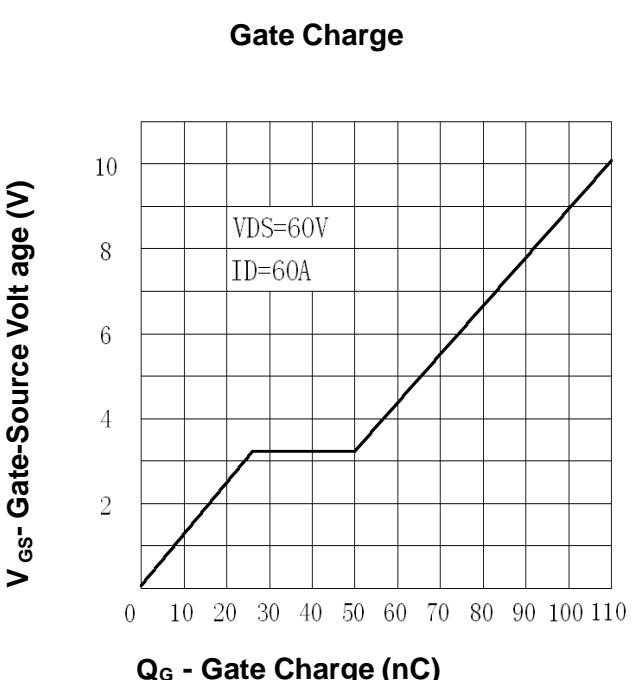
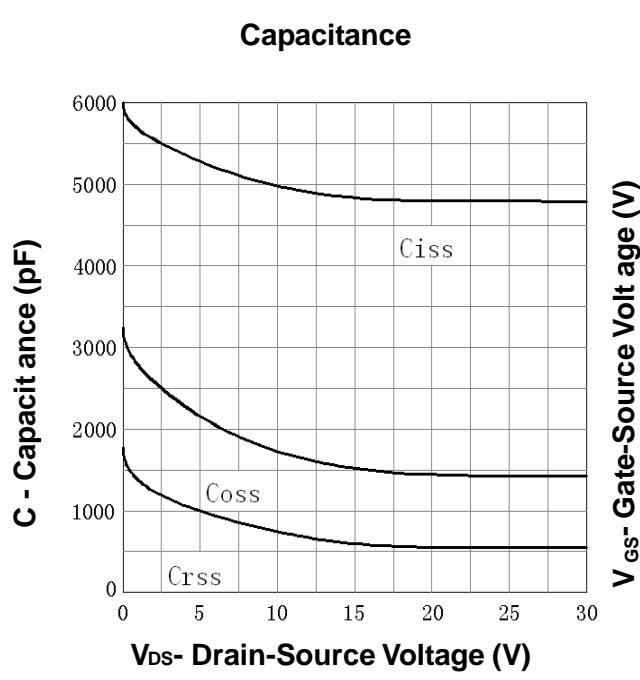
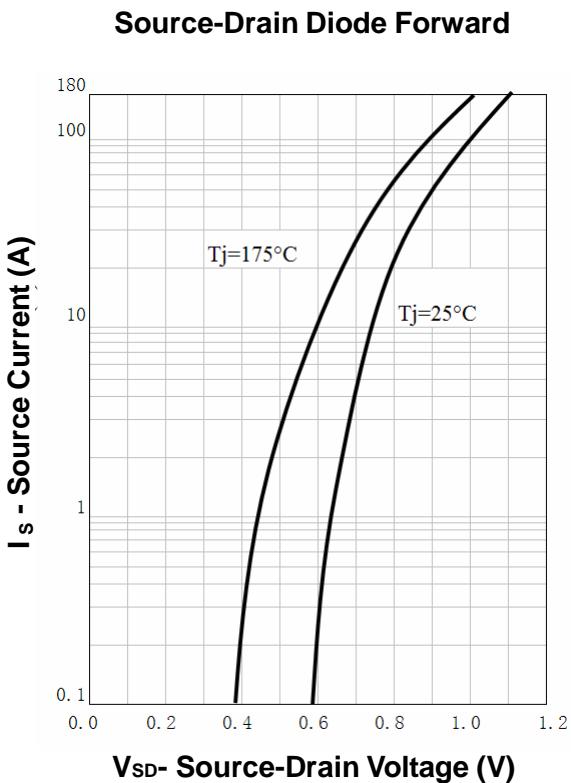
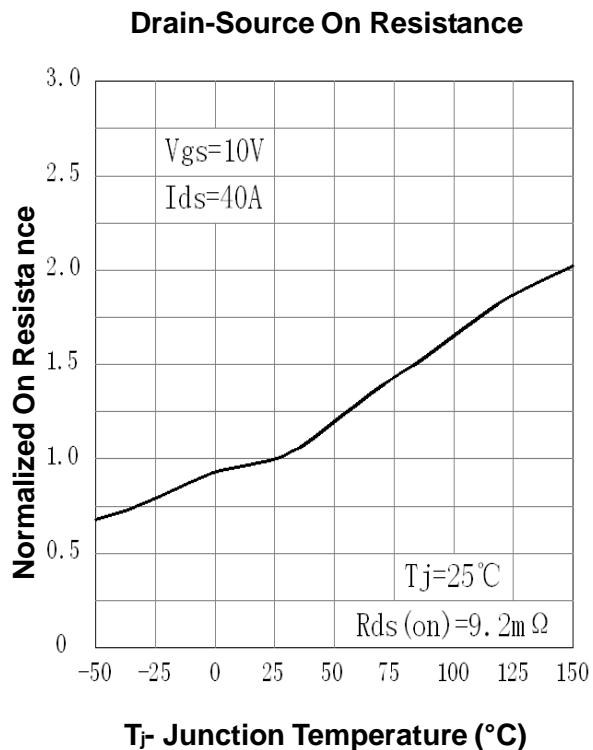


Square Wave Pulse Duration (sec)

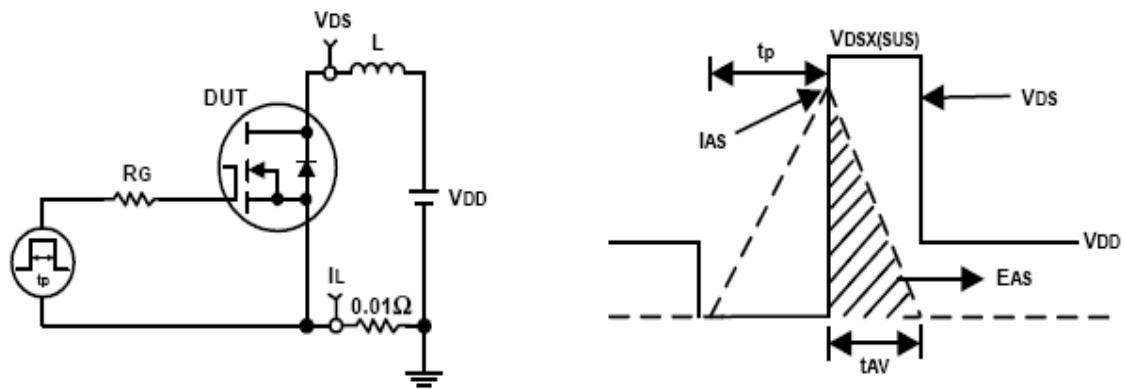
Typical Characteristics



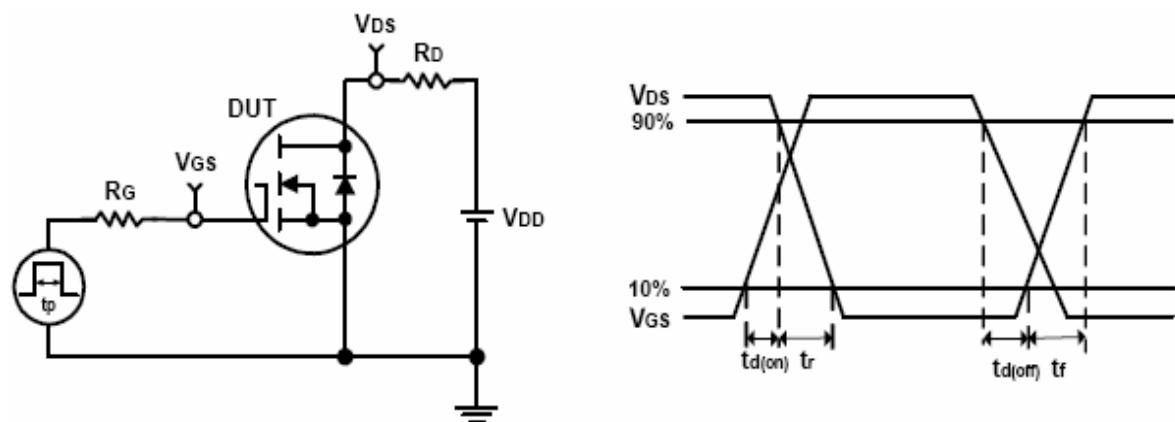
Typical Characteristics



Avalanche Test Circuit and Waveforms



Switching Time Test Circuit and Waveforms



Package Outline

Dimensions are shown in millimeters

M: TO-252

